

COMPLIANT

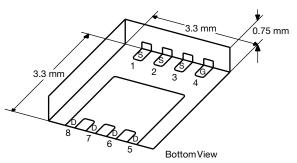
HALOGEN FREE

**Vishay Siliconix** 

## P-Channel 30 V (D-S) MOSFET

PRODU	PRODUCT SUMMARY					
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω) Max.	I <sub>D</sub> (A)	Q <sub>g</sub> (Typ.)			
	0.0056 at V <sub>GS</sub> = - 10 V	- 50 <sup>e</sup>				
- 30	0.0070 at V <sub>GS</sub> = - 6 V	- 50 <sup>e</sup>	45 nC			
	0.0090 at $V_{GS}$ = - 4.5 V	- 50 <sup>e</sup>				

#### PowerPAK 1212-8S

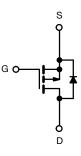


### **FEATURES**

- TrenchFET<sup>®</sup> Power MOSFET
- Low Thermal Resistance PowerPAK<sup>®</sup> Package with Small Size and Low 0.75 mm Profile
- 100 % R<sub>g</sub> and UIS Tested
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

### **APPLICATIONS**

- Notebook Computers and Mobile Computing
  - Adaptor Switch
  - Load Switch
  - DC/DC Converter
  - Power Management



P-Channel MOSFET

Ordering Information: SiSS27DN-T1-GE3 (Lead (Pb)-free and Halogen-free)

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage	V <sub>DS</sub>	- 30	v		
Gate-Source Voltage		V <sub>GS</sub>	± 20	v	
	T <sub>C</sub> = 25 °C		- 50 <sup>e</sup>		
Continuous Drain Current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 70 °C		- 50 <sup>e</sup>		
	T <sub>A</sub> = 25 °C	I <sub>D</sub>	- 23 <sup>a, b</sup>		
	$T_A = 70 ^{\circ}C$ - 18.5 <sup>a, b</sup>	- 18.5 <sup>a, b</sup>			
Pulsed Drain Current (t = 100 μs)	I <sub>DM</sub>	- 200	— A		
	T <sub>C</sub> = 25 °C	L.	- 47.5		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	- 4 <sup>a, b</sup>		
Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	- 25		
Single-Pulse Avalanche Energy	L = 0.1 mm	E <sub>AS</sub>	31	mJ	
	T <sub>C</sub> = 25 °C		57		
Mauinum Davier Dissingtion	T <sub>C</sub> = 70 °C	P <sub>D</sub>	36	w	
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	ГD	4.8 <sup>a, b</sup>	vv	
	T <sub>A</sub> = 70 °C 3 <sup>a, b</sup>	3 <sup>a, b</sup>			
Dperating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 50 to 150	°C	
Soldering Recommendations (Peak Temperature) <sup>c, c</sup>	d		260	-0	

#### Notes:

a. Surface mounted on 1" x 1" FR4 board.

b. t = 10 s.

- c. See solder profile (www.vishay.com/doc?73257). The PowerPAK 1212-8S is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- d. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.

e. Package limited.

### **Vishay Siliconix**



### THERMAL RESISTANCE RATINGS

	Symbol	Typical	Maximum	Unit
t ≤ 10 s	R <sub>thJA</sub>	21	26	°C/W
Steady State	R <sub>thJC</sub>	1.7	2.2	C/VV
	t ≤ 10 s	Symbol   t ≤ 10 s R <sub>thJA</sub>	Symbol Typical   t ≤ 10 s R <sub>thJA</sub> 21	Symbol Typical Maximum   t ≤ 10 s R <sub>thJA</sub> 21 26

Notes:

a.Surface mounted on 1" x 1" FR4 board. b.Maximum under steady state conditions is 63 °C/W.

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static				<b></b>	<u> </u>	
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = - 250 μA	- 30			V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	1 050 4		- 22		mV/
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = - 250 μA		5.7		°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 1		- 2.2	V
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA
Zara Cata Valtaga Drain Current	1	V <sub>DS</sub> = - 30 V, V <sub>GS</sub> = 0 V			- 1	
Zero Gate Voltage Drain Current	IDSS	V <sub>DS</sub> = - 30 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C			- 10	μA
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le -5 \text{ V}, \text{ V}_{GS} = -10 \text{ V}$	- 20			Α
		V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 15 A		0.0046	0.0056	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 6 V, I <sub>D</sub> = - 10 A		0.0058	0.0070	Ω
		$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -5 \text{ A}$		0.0073	0.0090	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 15 V, I <sub>D</sub> = - 15 A		52		S
Dynamic <sup>b</sup>		•		•		
Input Capacitance	C <sub>iss</sub>			5250		pF
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = - 15 V, V <sub>GS</sub> = 0 V, f = 1 MHz		530		
Reverse Transfer Capacitance	C <sub>rss</sub>			485		
Tatal Cata Charge	Q <sub>g</sub> Q <sub>gs</sub>	$V_{DS} = -15 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -20 \text{ A}$		92	140	nC
Total Gate Charge				45	70	
Gate-Source Charge		$V_{DS} = -15 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -20 \text{ A}$		15		
Gate-Drain Charge	Q <sub>qd</sub>			16		
Gate Resistance	R <sub>a</sub>	f = 1 MHz	0.6	3	6	Ω
Turn-On Delay Time	t <sub>d(on)</sub>			60	120	
Rise Time	t <sub>r</sub>	V <sub>DD</sub> = - 15 V, R <sub>I</sub> = 1.5 Ω		45	90	
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_{D} \cong -10$ Å, $V_{GEN} = -4.5$ V, $R_{g} = 1$ $\Omega$		50	100	
Fall Time	t <sub>f</sub>			20	40	
Turn-On Delay Time t <sub>d(or</sub>				16	30	ns
Rise Time	t <sub>r</sub>	V <sub>DD</sub> = - 15 V, R <sub>I</sub> = 1.5 Ω		5	10	
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D \cong -10$ Å, $V_{GEN} = -10$ V, $R_g = 1$ $\Omega$		65	130	
Fall Time	t <sub>f</sub>	, , , , , , , , , , , , , , , , , , ,		10	20	
<b>Drain-Source Body Diode Characterist</b>	ics					
Continuous Source-Drain Diode Current	ا <sub>s</sub>	T <sub>C</sub> = 25 °C			- 50 <sup>c</sup>	
Pulse Diode Forward Current <sup>d</sup>					- 200	A
Body Diode Voltage	V <sub>SD</sub>	I <sub>F</sub> = - 10 A		- 0.8	- 1.2	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>			30	60	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			21	40	nC
Reverse Recovery Fall Time	t <sub>a</sub>	– I <sub>F</sub> = - 10 A, dl/dt = 100 A/μs, T <sub>J</sub> = 25 °C		16		
Reverse Recovery Rise Time	t <sub>b</sub>	1		14		ns

Notes:

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %. b. Guaranteed by design, not subject to production testing. c. Package limited.

d.  $t = 100 \ \mu s$ .

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

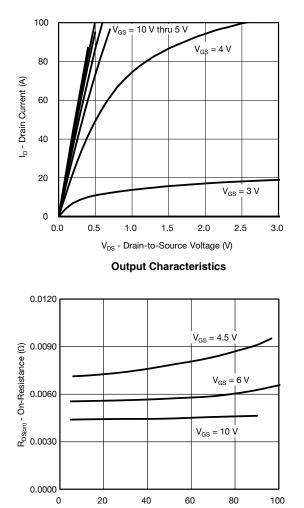
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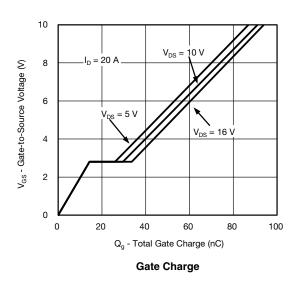


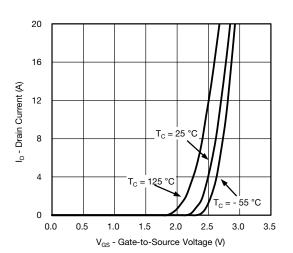
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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

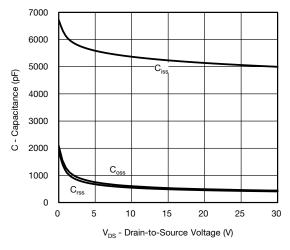


I<sub>D</sub> - Drain Current (A) On-Resistance vs. Drain Current and Gate Voltage

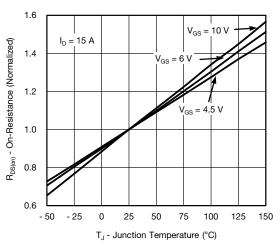




**Transfer Characteristics** 







**On-Resistance vs. Junction Temperature** 

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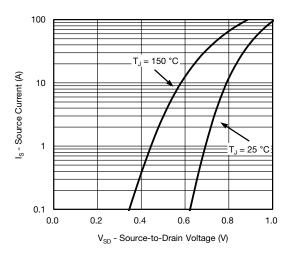
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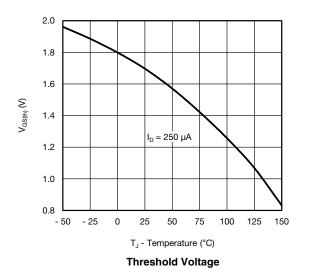


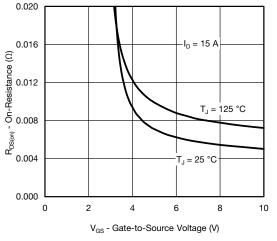
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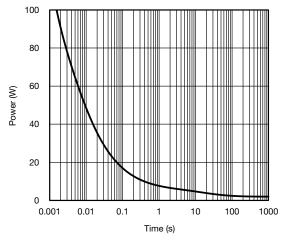


Source-Drain Diode Forward Voltage

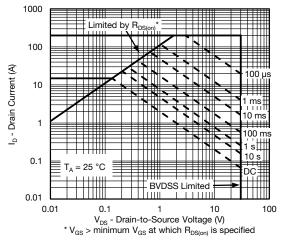




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient

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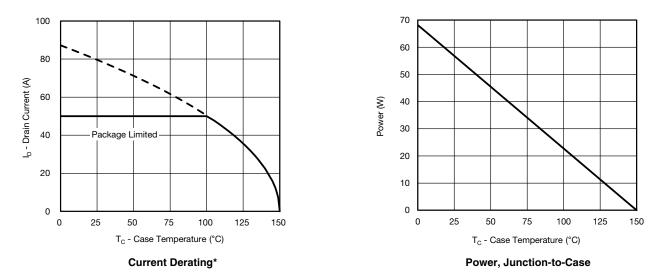
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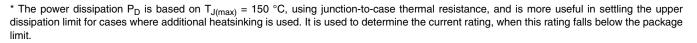
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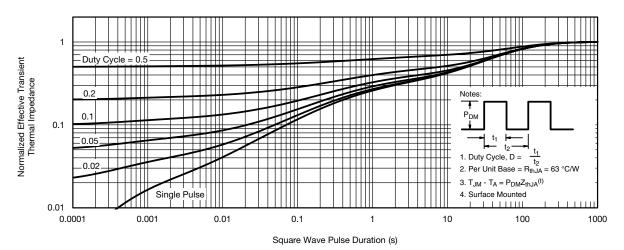


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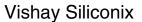


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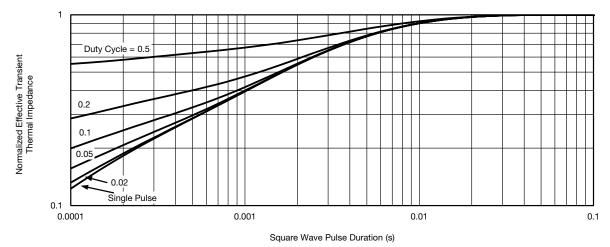


Normalized Thermal Transient Impedance, Junction-to-Ambient





### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg262847">www.vishay.com/ppg262847</a>.

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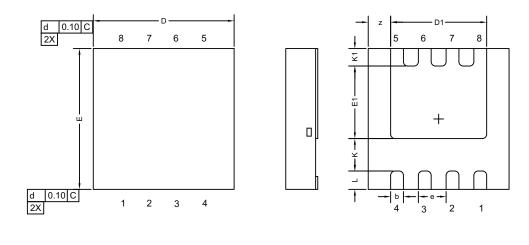
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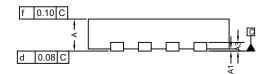
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# Case Outline for PowerPAK<sup>®</sup> 1212-8S





DIM.		MILLIMETERS			INCHES			
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.		
А	0.67	0.75	0.83	0.027	0.030	0.033		
A1	0	-	0.05	0	-	0.002		
A3		0.20 REF			0.008 REF			
b	0.30 BSC			0.012 BSC				
D	3.30 BSC 0.130 BSC							
D1	2.15	2.25	2.35	0.084	0.088	0.092		
E		3.30 BSC			0.130 BSC			
E1	1.60	1.70	1.80	0.063	0.067	0.071		
е	0.65 BSC				0.026 BSC			
К	0.76 TYP			0.030 TYP				
K1	0.41 TYP			D 0.016 TYP				
L	0.43 BSC			0.017 BSC				
Z	0.525 TYP			0.021 TYP				

Note

• Millimeters will govern.



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